

## DESCRIPTION

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material-Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size /cost. Its high reliability ensures robust operation during surge or over-voltage conditions.

## FEATURES

- Max Junction Temperature 175°C
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery

## MECHANICAL DATA

- Case: JEDEC TO-220AB/ITO-220AB/TO-263AB
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum

## TYPICAL APPLICATIONS

- General Purpose
- SMPS, Solar inverter, UPS
- Power Switching Circuits

## MAXIMUM RATINGS

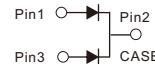
(Ratings at 25°C ambient temperature unless otherwise specified )

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	$V_{RRM}$	650	V
Continuous Rectified Forward Current	$I_F$	20	A
Repetitive Forward Surge Current(NOTE 1)	$I_{F, RM}$	70	A
Operating junction temperature range	$T_J$	-55 to +175	° C
Storage temperature range	$T_{stg}$	-55 to +175	° C

Notes: 1.Half-Sine Pulse,  $t_p=8.3\text{ms}$

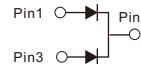
### TO-220AB

SC2065CT



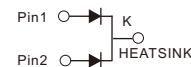
### ITO-220AB

SC2065FCT



### TO-263

SC2065D1



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 1  
 2

## RATINGS AND CHARACTERISTIC

### ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit	
Instantaneous forward voltage	$I_F=20A$	$T_A=25^\circ C$	$V_F$	1. 5	1. 8	V	
		$T_A=175^\circ C$		1. 7	2. 0		
Reverse current	$V_R=650V$	$T_A=25^\circ C$	$I_R$	–	10	$\mu A$	
		$T_A=125^\circ C$		–	40		
		$T_A=175^\circ C$		–	100		
Typical junction capacitance (Pre Diode)	$V_R=1V, f=100kHz$		$C_J$	450	–	$pF$	
	$V_R=10V, f=100kHz$			220	–		
	$V_R=40V, f=100kHz$			125	–		

### THERMAL CHARACTERISTICS ( $T_A=25^\circ C$ Unless otherwise noted)

Parameter	Symbol	SC2065CT	SC2065FCT	SC2065D1	Unit
Typical thermal resistance <sup>2)</sup>	$R_{\theta JC}$	2.5	4.5	2.5	$^\circ C/W$

2.Thermal resistance from junction to case

# RATINGS AND CHARACTERISTIC

FIG.1-FORWARD CURRENT DERATING CURVE

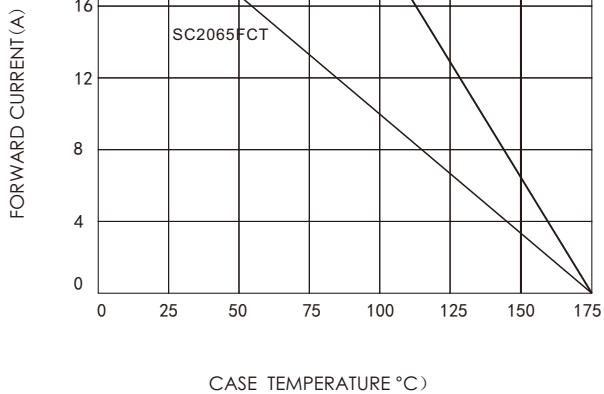


FIG.2-FORWARD CHARACTERISTICS (Pre Diode)

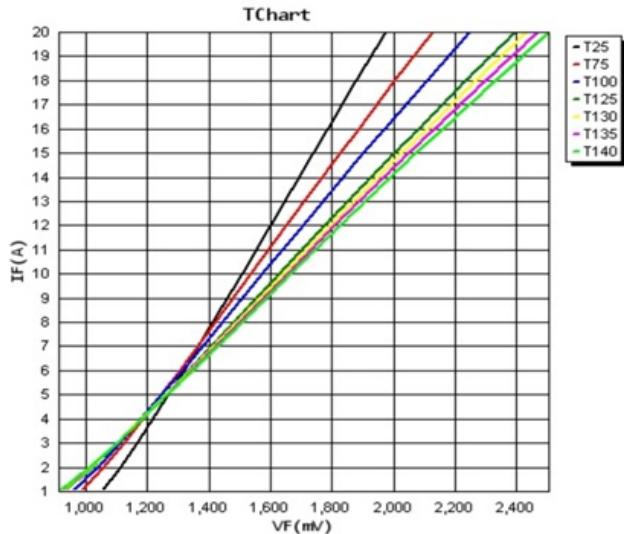


FIG.3-TYPICAL JUNCTION CAPACITANCE

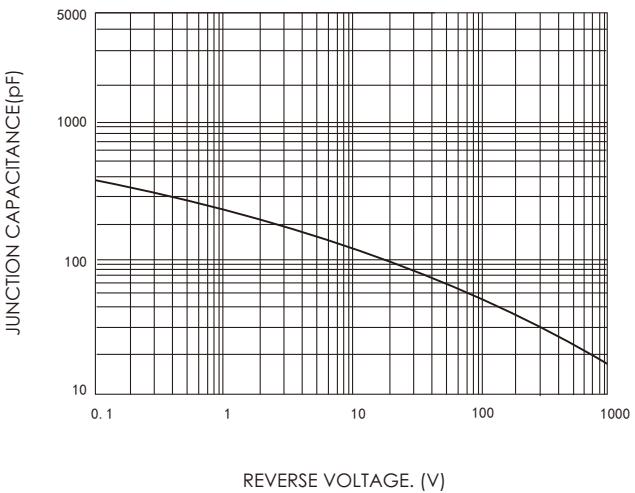
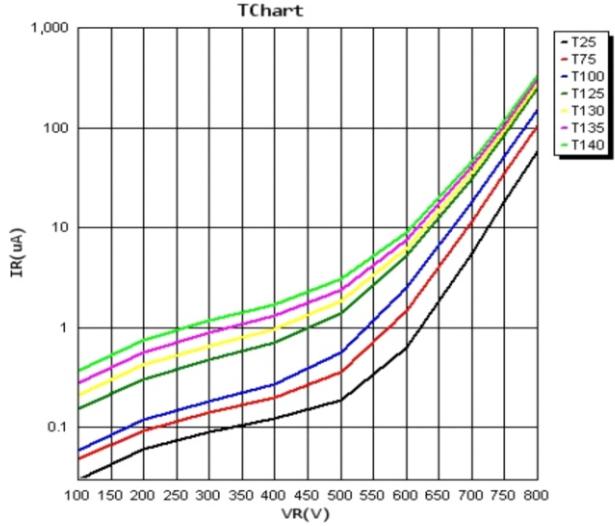


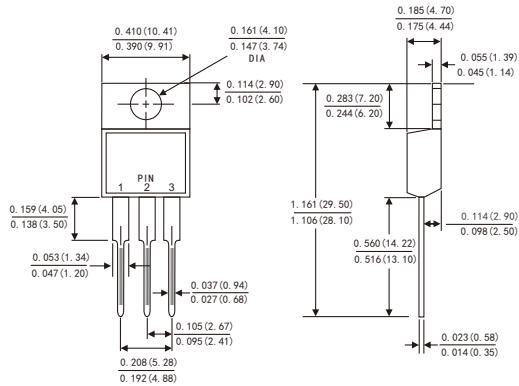
FIG.4-REVERSE CHARACTERISTICS(Pre Diode)



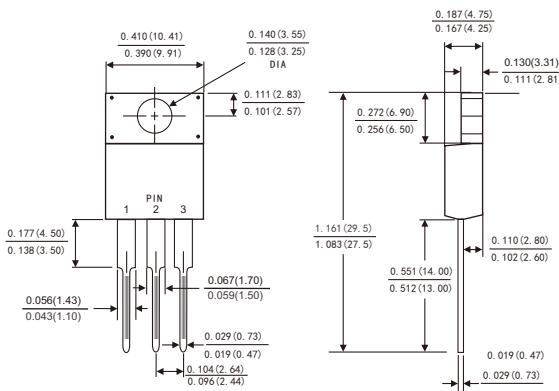
# PACKAGE OUTLINE DIMENSIONS

Dimensions in inches and (millimeters)

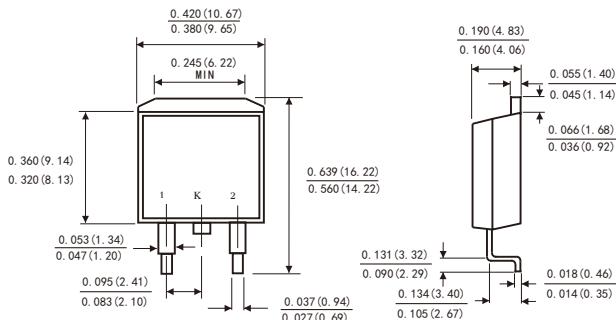
TO-220AB



ITO-220AB



TO-263



Suggested Pad Layout

(TO-263)

